

LOCTITE ABLESTIK ABP 8420

November 2017

PRODUCT DESCRIPTION

LOCTITE ABLESTIK ABP 8420 provides the following product characteristics:

Technology	Epoxy
Appearance	Black
Cure	Heat cure
Product Benefits	<ul style="list-style-type: none"> • Non-conductive • Excellent resin bleed out (RBO) performance • Fast cure • Black pigmentation for blocking stray light • Good adhesion to PA substrates • Good reliability performance
Application	Die attach
Key Substrates	Most plastics and Glass
Typical Applications	Cap, diffuser attach in wirebond packages

LOCTITE ABLESTIK ABP 8420 non-conductive adhesive is designed for cap and lid attach applications in wirebond packages. This adhesive can be fast cured using directed heat energy or hot plate curing techniques. LOCTITE ABLESTIK ABP 8420 will cure at temperatures as low as 80°C in conventional box or convection conveyor oven curing.

If used over an active die face, an adhesive bondline thickness of >1 mil must be maintained to prevent die scarring.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Thixotropic Index (0.5/5 rpm)	5.8
Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	13,500
Work Life @ 25°C, hours	24
Shelf Life @ -20°C (from date of manufacture), 180 days	

TYPICAL CURING PERFORMANCE

Weight Loss on Cure

Weight Loss on Cure, %	0.5
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Cure Schedule

30 minutes ramp to 150°C, hold 15 minutes @ 150 °C

Alternate Cure Schedule

30 minutes @ 100°C or
120 minutes @ 80°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

Glass Transition Temperature (Tg) by TMA, °C	75
Coefficient of Thermal Expansion, :	
Below Tg, ppm/°C	54
Above Tg, ppm/°C	154
Thermal Conductivity, W/(m-K)	0.3
Extractable Ionic Content, @ 100°C:	
Chloride (Cl-)	<120
Sodium (Na+)	<5
Potassium (K+)	<5
Water Extract Conductivity, µmhos/cm	147
Weight Loss, %	0.5
DMA Modulus :	
@ 25°C	N/mm ² 2,850 (psi) (413,357)
@ 100°C	N/mm ² 1,919 (psi) (278,327)
@ 150°C	N/mm ² 90 (psi) (13,053)
@ 250°C	N/mm ² 84 (psi) (12,183)

TYPICAL PERFORMANCE OF CURED MATERIAL

Sample cured 15 minutes @ 150°C

Miscellaneous

Die Shear Strength, kg-f	
1 x 1 mm Si die on glass	6
2 x 2 mm Si die:	
on GBA	15.5
on PA	12
on Cu LF	13
3 x 3 mm Glass die on PC	12

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage : -20 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$
 $\text{kV/mm} \times 25.4 = \text{V/mil}$
 $\text{mm} / 25.4 = \text{inches}$
 $\text{N} \times 0.225 = \text{lb/F}$
 $\text{N/mm} \times 5.71 = \text{lb/in}$
 $\text{psi} \times 145 = \text{N/mm}^2$
 $\text{MPa} = \text{N/mm}^2$
 $\text{N} \cdot \text{m} \times 8.851 = \text{lb} \cdot \text{in}$
 $\text{N} \cdot \text{m} \times 0.738 = \text{lb} \cdot \text{ft}$
 $\text{N} \cdot \text{mm} \times 0.142 = \text{oz} \cdot \text{in}$
 $\text{mPa} \cdot \text{s} = \text{cP}$

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